

Features

- Fast response time
- Wide temperature range
- High surge current rating
- Low capacitance and insertion loss
- Stable performance throughout life
- Small surface mount package
- RoHS compliant*

Applications

- Set top boxes
- Industrial communications
- HVAC controls
- xDSL, POTS, G.Fast
- Antennae

GDT25 Series - Next-Generation 2-Electrode Gas Discharge Tube Arrestor

General Information

Bourns' new and improved next-generation surface mount 2-electrode GDT surge protection devices have been designed using Bourns' proprietary, advanced computer simulation techniques and offer industry-leading maximum impulse voltage limiting specifications in a small, environmentally rugged surface mount package. The performance delivered in the Bourns® GDT25 Series helps to significantly heighten protection against induced voltage transients such as lightning and AC induction. Plus, the enhanced level of protection with tighter voltage limiting provided during fast-rising events will reduce stress on downstream components compared to current GDT designs in the same application.

Product Characteristics

Storage Temperature Range	55 °C to +125 °C
Operating Temperature Range	55 °C to +125 °C
Climate Category (IEC 60068-1)	55 / 125 / 21
Moisture Sensitivity Level (MSL)	1
ESD Classification - HBM	

How to Order

Description —	GDT 2 5 - xx - S1 - RP
GDT = Gas Discharge Tube - Next-Generation Series	
Electrodes	
2 = 2-Electrode	
Size — 5 = 5 mm Diameter	
Voltage 07 = 75 V 09 = 90 V 35 = 350 V 60 = 600 V	
Package DesignatorS1 = 5 x 4.4 mm SMD (Standard)	
Packaging Options RP = Reel Pack (Standard) Blank = Cut Tape	

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Additional Information

Click these links for more information:









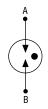


INVENTORY

Agency Recognition

Agency	Category	Agency File No.
91 3° UL	497B - 4th Edition	E153537

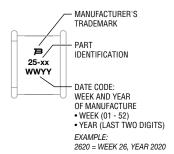
Circuit Diagram



Note: Gas discharge tubes are bidirectional and non-polarized.

Typical Part Marking

Represents total content. Layout may vary.





BK = Bulk

WARNING Cancer and Reproductive Harm - www.P65Warnings.ca.gov

Electrical Characteristics

Test Methods per ITU-T K.12, IEEE C62.31 and IEC 61643-311 GDT standards.

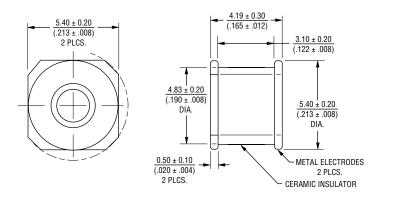
	Device Specifications (1)									
Bourns Part No.	DC Sparkover Voltage ±20 % (2) (3) (4)			Insulation Resistance (IR)	Glow Voltage	Arc Voltage	Glow to Arc Transition Current	Capacitance	DC Holdover Voltage	
	100 V/s	100 V/μs	1 kV/μs	(7)	10 mA	> 1 A		1 MHz	< 150 ms	
GDT25-07	75 V	350 V	600 V	> 2 GΩ						52 V
GDT25-09	90 V	350 V	500 V		~ 70 V	~ 5 V	< 1 A	406 pF	52 V	
GDT25-35	350 V	650 V	800 V		~ 70 V	~ 5 V	< 1 A	< 0.6 pF	135 V	
GDT25-60	600 V	1000 V	1100 V						135 V	

	Life Ratings ⁽⁹⁾					
Bourns Part No.	Max. Surge Current	Nominal Impulse Discharge Current			Nomir Discharge	
	8/20 μs	8/20 μs	10/350 μs	10/1000 μs	11 Cycles @ 60 Hz	1 Second
GDT25-07		10 kA 7 kA 1 kA 1 Operation 10 Operations 1 Operation 30	1 kA	100 A	20 Arms 1 Operation	7 Arms
GDT25-09	10 kA				25 Arms 1 Operation	
GDT25-35	1 Operation		300 Operations	20 Arms 1 Operation	10 Operations	
GDT25-60					25 Arms 1 Operation	

Notes:

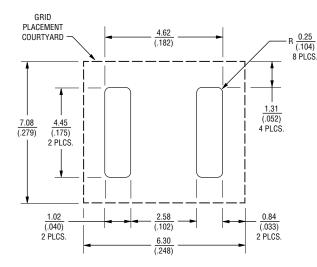
- ⁽¹⁾ At delivery AQL 0.65 Level II, DIN ISO 2859.
- (2) DC and Impulse Sparkover values are in ionized mode @ 25 °C.
- (3) Bourns recommends reflowing surface mount devices per *IPC/JEDEC J-STD-020 rev. D.*
- (4) Surface mount GDTs may exhibit a temporary increase in the DC Sparkover Voltage after the solder reflow process. The DC Sparkover Voltage will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary increase in DC Sparkover Voltage.
- (5) Impulse Sparkover voltage is expressed as a maximum value, with a 99 % probability of measured values within limit.
- (6) IR limits after Life Ratings > 100 M Ω .
- (7) IR Test Voltage: 50 V for GDT25-07 and GDT25-09, 100 V for GDT25-35 and GDT25-60.
- (8) Network applied (per ITU-T K.12 Edition 9.0, Section 7).
- (9) DC Sparkover Voltage limits after Life Ratings may exceed +20 % but will continue to protect without venting (per ITU-T K.12 Edition 9.0, Section 6, where applicable).

Product Dimensions



MM DIMENSIONS: (INCHES)

Recommended Pad Layout



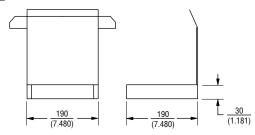
MM DIMENSIONS: (INCHES)

Note: Recommended PCB land pattern in compliance with IPC-7351.

Packaging Specifications

Model	S	Standard Packaging Quantity			
Model	Bulk (Bag)	Вох	Reel	Cut Tape	
GDT25				500	
GDT25-BK	250	1000			
GDT25-RP			1500		

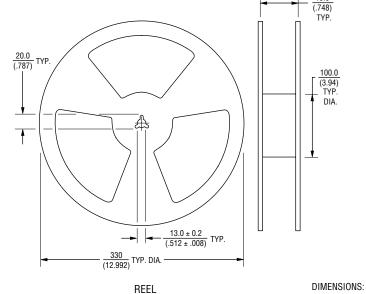
CUT TAPE



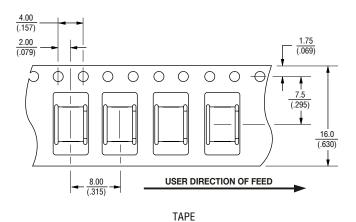
Contains 500 pieces in carrier tape within a carton box.

MM (INCHES) DIMENSIONS:

REEL PACK



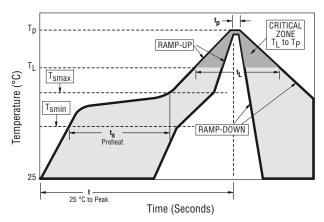
Reel is 330 mm in diameter and 19 mm wide.



TOLERANCES (EXCEPT WHERE NOTED): X.X DEGREES

(INCHES)

Soldering Parameters - Reflow Soldering



Notes:

Bourns recommends reflowing surface mount devices per IPC/JEDEC J-STD-020 rev D.

Surface mounted components (SMD) may exhibit a temporary increase in the DC Sparkover Voltage after the solder reflow process. The components should recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC Sparkover Voltage.

Reflow C	condition	Pb-free Assembly			
	Temperature Min. (T _{S(min)})	150 °C			
Preheat	Temperature Max. (T _{S(max)})	200 °C			
	Time (Min. to Max.) (T _S)	60 - 120 seconds			
	Ramp-up Rate Temperature (T _L) to Peak)	3 °C / second max.			
T _{S(max)} to	o T _L - Ramp-up Rate	5 °C / second max.			
Reflow	Temperature (T _L) (Liquidus)	217 °C			
Hellow	Temperature (T _L)	60 - 150 seconds			
Peak Temperature (T _p)		260 +0/-5 °C			
Time within 5 °C of Actual Peak Temperature (T _p)		10 – 30 seconds			
Ramp-down rate		6 °C / second max.			
Time from 25 °C to Peak Temperature (T _p)		8 minutes max.			
Do not Ex	ceed	260 ° C			

Soldering Parameters - Hand Soldering